

Specification for TFT

AFR240320A0-1.77INTM-I

Revision V1.0



А	Orient Display
FR	ТFТ Туре
240320	Resolution 240 x 320
A0	Serial A0
1.77	1.77", Module Dimension 34.70 x 46.70 x 2.5 mm
1	IPS Display
Ν	Top: -20~+70°C; Tstr: -30~+80°C
Т	Transmissive/Normally Black
Μ	Medium Brightness, 500cd/m2
/	No Touch Panel
1	Controller JD9852
/	MIPI + one data lane Interface



Revision History

Date	Rev. No.		Summary
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1.Basic Information

* Description

This is a color active matrix TFT (Thin Film Transistor) LCD (liquid crystal display) that uses amorphous silicon TFT as a switching device. This module is composed of a Transmissive type TFT-LCD Panel, driver circuit, back-light unit. The resolution of a 1.77"TFT-LCD contains 240X320 pixels, and can display up to 65K/262K colors.

1.1 Features

General Information	Specification	Unit	Note	
Items	Main Panel		Note	
Display area(AA)	26.64(H)*35.52(V) (1.77inch)	mm	-	
Driver element	TFT active matrix	-	-	
Display colors	65K/262K	colors	-	
Number of pixels	240(RGB)*320	dots	-	
Pixel arrangement	RGB vertical stripe	-	-	
Pixel pitch	0.111(H)*0.111(V)	mm	-	
Viewing angle	ALL	o'clock	-	
Controller IC	JD9852	-	-	
LCM Interface	MIPI+one data lane	-	-	
Display mode	Transmissive/Normally Black	-	-	
Operating temperature	-20 ~ +70	°C	-	
Storage temperature	-30~+80	°C	-	

1.2 Mechanical Information

Item		Min.	Тур.	Max.	Unit	Note
	Horizontal(H)		34.7		mm	-
Module size	Vertical(V)		46.7		mm	-
0.20	Depth(D)		2.5		mm	-
Weight			6		g	-

2. Block Diagram



3.Outline Dimension



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4. Input terminal Pin Assignment

Pin NO.	Symbol	Function	I/O
1	NC		
2	LEDK	Cathode pin of backlight.	Ρ
3	NC		
4	LEDA	Anode pin of backlight.	Ρ
5	NC		
6	VCI	Supply voltage (3.3V).	Ρ
7	IOVCC	Power supply for I/O block(1.8-3.3V)	Ρ
8	TE	Serve as a TE (Tearing Effect) output signal	0
9	RESET	Reset pin. Setting either pin low initializes the LSI. Must be reset after power is supplied.	I
10	GND	Ground.	Ρ
11	NC		
12	NC		
13	GND	Ground.	Р
14	MIPI_CL P	DSI Positive polarity of low voltage differential clock signal	I
15	MIPI_CL N	DSI Negative polarity of low voltage differential clock signa I	
16	GND	Ground.	Ρ
17	MIPI_D0 P	DSI Positive polarity of low voltage differential data signal	I
18	MIPI_D0 N	DSI Negative polarity of low voltage differential data signal	Ι
19	GND	Ground.	Р
20	GND	Ground.	Ρ

5.LCD Optical Characteristics

5.1 Optical specification

ltem		Symbol	Condition	Min.	Тур.	Max.	Unit.	Note
Contrast Ratio		CR	Θ=0	500	600			*
Response - time	Rising Falling	T _{R+} T _F	Normal viewing		35	50	msec	*
Color gar		S(%)	angle		49.3		%	*
		W _X		0.2454	0.2854	0.3254	70	
	White	W _Y		0.2716	0.3116	0.3516		
		R _x		0.5604	0.6004	0.6404		
Color Filter	Red			0.3208	0.3608	0.4008		CA310
Chromacicity	Green	Gx		0.2958	0.3358	0.3758		Test
		G _Y		0.5142	0.5542	0.5942		
		B _X		0.1198	0.1598	0.1998		
	Blue	B _Y		0.0732	0.1132	0.1532		
	Llor	ΘL		60	85			
Viewing	Hor.	Θr	00.40	60	85			*
angle		Θυ	CR>10	60	85			~
	Ver. OD			60	85			
Option Vi Directio	n			ALL				

*The data comes from the LCD specification.

5.2 Measuring Condition

- Measuring surrounding : dark room
- Ambient temperature : 25±2℃
- 15min. warm-up time.

5.3 Measuring Equipment

Note (1) Definition of Viewing Angle:



Note (2) Definition of Contrast Ratio (CR): measured at the center point of panel

Luminance with all pixels white

CR = -

Luminance with all pixels black

Note (3) Definition of Response Time: Sum of T_R and T_F



Note (4) Definition of optical measurement setup



6.Electrical Characteristics

Item	Symbol	Rating	Unit
Supply Voltage	VCI	-0.3~4.6	V
Digital interface supply Voltage	IOVCC	-0.3~4.6	V
Operating temperature	TOP	-20~+70	°C
Storage temperature	Tst	-30~+80	°C

6.1 Absolute Operation Rating (Ta=25 VSS=0V)

Note: If one of the above items is exceeded its maximum limitation momentarily, the quality of the product may be degraded.

Absolute maximum limitation, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the recommend range.

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Supply Voltage	VCI	2.4	3.3	3.6	V	
Digital interface supply Voltage	IOVCC	1.65	1.8	3.3	V	
Normal mode Current consumption	IDD		TBD		mA	
Level input voltage	Vін	0.7 IOVCC		IOVCC	V	
	Vil	GND		0.3 IOVCC	V	
Level output voltage	Vон	0.8 IOVCC		IOVCC	V	
	Vol	GND		0.2 IOVCC	V	

6.2 DC Electrical Characteristics

6.3 LED Backlight Characteristics

ltem	Symbol	Min.	Тур.	Max.	Unit	Note
Forward Current	lF	15	20		mA	
Forward Voltage	VF		9.6		V	
LCM Luminance	Lv	450	500		cd/m2	Note3
LED life time	Hr	50000			Hour	Note1,2
Uniformity	AVg	80			%	Note3

The back-light system is edge-lighting type with 4 chips White LED

Note (1) LED life time (Hr) can be defined as the time in which it continues to operate under the condition: Ta=25±3 ℃, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note (2) The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25 $^{\circ}$ C and IL=20mA. The LED lifetime could be decreased if operating IL is larger than 20mA. The constant current driving method is suggested.



NOTE 3 : Luminance Uniformity of these 9 points is defined as below:



7.AC Characteristic

7.1 Reset Input Timing



* Reset input timings

Symbol	Parameter	Related pins	Min.	Max.	Unit
t _{RW}	Reset pulse width ⁽²⁾	RESX	10	-	μs
	Reset complete time ⁽³⁾	-	-	5 (Note 5)	ms
t _{RT}	Reset complete time	-	-	120 (Note 6, 7)	ms

Note: (1) The reset complete time also required time for loading ID bytes from OTP to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX. (2) Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the

table below.

RESX Pulse	Action
Shorter than 5 µs	Reset Rejected
Longer than 10 µs	Reset
Between 5 µs and 10 µs	Reset Start

(3) During the resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out -mode. The display remains the blank state in Sleep In -mode) and then returns to Default condition for H/W reset.

(4) Spike Rejection also applies during a valid reset pulse as shown below:



(5) When Reset is applied during Sleep In Mode.(6) When Reset is applied during Sleep Out Mode.(7) It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

7.2 Timings for DSI Video mode



Vertical Timings for DSI Video mode I/F

Resolution=240x320 (TA=25°C, IOVCC=1.8V, VCI=2.8V)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Vertical low pulse width	VS	-	2	1.70	Note(1)	Line
Vertical front porch	VFP	- 600	2	-	(i 4)	Line
Vertical back porch	VBP	-	2	2.50	Note(1)	Line
Vertical blanking period	VBK	VS+VBP+VFP	6	-	-	Line
Vertical active area		VDISP	5	320		Line
Vertical Refresh rate	VRR	-	-	60	0-0	Hz

Vertical Timings for DSI Video mode I/F

Horizontal Timings



Horizontal Timing for DSI Video mode I/F

Resolution=240x320 (TA=25°C, IOVCC=1.8V, VCI=2.8V)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
HS low pulse width	HS	-	6	- 10	78	DCK
Horizontal back porch	HBP	- ()	5		78	DCK
Horizontal front porch	HFP	-	5	(H)	78	DCK
Horizontal blanking period	HBLK	HS+HBP+HFP	16	1.977	88	DCK
Horizontal active area	HDISP		-	240	-	DCK

Note: (1) HS+HBP>0.5uS.

(2) HFP>0.5uS.

Horizontal Timings for DSI Video mode I/F

8.LCD Module Out-Going Quality Level

8.1 VISUAL & FUNCTION INSPECTION STANDARD

8.1.1 Inspection conditions



8.1.2 Definition



Zone A : Effective Viewing Area(Character or Digit can be seen)

Zone B : Viewing Area except Zone A

Zone C : Outside (Zone A+Zone B) which can not be seen after assembly by customer .) Zone D : IC Bonding Area

Note:

As a general rule ,visual defects in Zone C can be ignored when it doesn't effect product function or appearance after assembly by customer

8.1.3 Sampling Plan

According to GB/T 2828-2003 ; , normal inspection, Class $\, \mathbb{I} \,$ AQL:

Major defect	Minor defect
0.65	1.5

LCD: Liquid Crystal Display , TP: Touch Panel , LCM: Liquid Crystal Module

No	Items to be inspected	Criteria	Classification of defects
1	Functional defects	 No display, Open or miss line Display abnormally, Short Backlight no lighting, abnormal 	
		lighting. 4) TP no function	Major
2	Missing	Missing component	Major
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	
4	Color tone	Color unevenness, refer to limited sample	
5	Spot Line defect	Light dot, Dim spot,Polarizer Bubble ; Polarizer accidented spot.	Minor
6	Soldering appearance	Good soldering , Peeling off is not allowed.	
7	LCD/Polarizer/TP	Black/White spot/line, scratch, crack, etc.	

8.1.4 Criteria (Visual)

Number	Items		Criteria(mm)	
1.0 LCD Crack/Broken NOTE: X: Length Y: Width Z: Height L: Length of ITO, T: Height of LCD	(1) The edge of LCD broken			
		Х	Y	Z
		≤3.0mm	<inner border="" line<br="">the seal</inner>	e of _≤T
	(2)LCD corner broken	$\begin{array}{c c} \hline X & Y & Z \\ \hline \leq 3.0 \text{mm} & \leq L & \leq T \end{array}$		
	(3) LCD crack		Crack Not allowed	

	Spot defect	① light dot (LCD, pinhole, dent, stai		black/white	spot ,	light dot,
		Zone		cceptable C	(ty	
		Size (mm)	A	В		С
2.0		Ф≤0.10	Igne	ore		
	I⊲ → X	0.10<Φ≤0.20	3(distance	e≧10mm)	1.	
	Φ=(X+Y)/2	0.20<Φ≤0.25	2	2	- IC	Inore
	+ (/(``)/2	Φ>0.3	0			
		②Dim spot (LCE) /TP/Polarizer	⁻ dim dot, li	ght le	akage、
		_dark spot)				
		Zone	A	cceptable Q	ty	
		Size (mm)	А	В		С
		Ф≤0.1	Igno	ore		
		0.10<Φ≤0.20	3(distance	e≧10mm)		nore
		0.20<Φ≤0.25	2		Ignore	
		Φ>0.3	0			
		③ Polarizer accid	•			
		Zone	A	cceptable Q	ty	
		Size (mm)	A	В		С
		Ф≤0.2	Igno	ore		
		0.3<Φ≤0.5	2(distance	e≧10mm)	lg	Inore
		Φ>0.5	0			
		④Pixel bad points	s (light dot, [Dim dot, col	or dot)
		Zone	A	cceptable C	(ty	
		Size (mm)	A		В	С
		Ф≤0.1	Igno	ore		
		0.15<Φ≤0.2	2(distance	e≧10mm)	lg	nore
		Φ>0.2	0			
		5 Polarizer Bubbl	e			
		Zone	Acceptable Qty		ty	
		Size (mm)	A	В		С
		Ф≤0.2	Igno			
		0.3<Φ≤0.4	3(distance≧10mm)		٦	nore
		0.4<Φ≤0.5	2		ıg	nore
		Φ>0.5	0			

		Width (mm)	Longth(mm)	Acceptable Qty		
	Line defect	Width(mm) Length(mm)		А	В	С
	(LCD/TP /Polarizer	Ф≤0.03	Ignore	Ignor	e	
3.0	backlight black/white	0.03 <w≤0.04< td=""><td>L≤3.0</td><td>N≤2</td><td>)</td><td>Ignore</td></w≤0.04<>	L≤3.0	N≤2)	Ignore
	line, scratch, stain)	0.04 <w≤0.05< td=""><td>L≤2.0</td><td>N≤1</td><td></td><td></td></w≤0.05<>	L≤2.0	N≤1		
	Stairty	0.05 <w< td=""><td colspan="3">Define as spot defect</td><td></td></w<>	Define as spot defect			
4.0	Electronic Components SMT	Not allow missing parts, solderless connection, cold solder joint, mismatch, The positive and negative polarity opposite				
5.0	Display color& Brightness	 Color: Measuring the color coordinates, The measurement standard according to the datasheet or samples. Brightness: Measuring the brightness of White screen, The measurement standard according to the datasheet or Samples. 				
6.0	LCD Mura	By 5% ND filter invisible.				

Criteria (functional items)

Number	Items	Criteria (mm)
1	No display	Not allowed
2	Missing segment	Not allowed
3	Short	Not allowed
4	Backlight no lighting	Not allowed

9. Reliability Test Result

Item	Condition	Inspection after test
High Temperature Operating	70℃,96H	
Low Temperature Operating	-20℃, 96HR	
High Temperature Storage	80℃, 96HR	
Low Temperature Storage	-30℃, 96HR	Inspection after 2~4hours storage at room
High Temperature & High Humidity Storage	+60 ℃, 90% RH ,96 hours.	temperature, the sample shall be free from defects:
Thermal Shock (Non-	-30 °C ,30 min ↔ 80 °C ,30 min,	1.Air bubble in the LCD;
operation)	Change time:5min 20CYC.	2.Non-display;
ESD test	C=150pF, R=330,5points/panel Air:±8KV, 5times; Contact:±6KV, 5 times; (Environment: 15℃~35℃, 30%~60%).	3.Missing segments/line; 4.Glass crack; 5.Current IDD is twice higher than initial value.
Vibration (Non- operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total) (Package condition).	anglior than initial value.
Box Drop Test	1 Corner 3 Edges 6 faces,80cm(MEDIUM BOX)	

Remark:

1. The test samples should be applied to only one test item.

2.Sample size for each test item is 5~10pcs.

3.For Damp Proof Test, Pure water(Resistance > 10M Ω) should be used.

4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.

5.Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

10. Cautions and Handling Precautions

10.1 Handling and Operating the Module

(1) When the module is assembled, it should be attached to the system firmly.

Do not warp or twist the module during assembly work.

(2) Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.

(3) Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.

(4) Do not allow drops of water or chemicals to remain on the display surface.

If you have the droplets for a long time, staining and discoloration may occur.

(5) If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.

(6) The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane.

Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.

(7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth.

In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.

(8) Protect the module from static; it may cause damage to the CMOS ICs.

(9) Use finger-stalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.

(10) Do not disassemble the module.

(11) Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.

(12) Pins of I/F connector shall not be touched directly with bare hands.

(13) Do not connect, disconnect the module in the "Power ON" condition.

(14) Power supply should always be turned on/off by the item 6.1 Power On Sequence &6.2 Power Off Sequence

10.2 Storage and Transportation.

(1) Do not leave the panel in high temperature, and high humidity for a long time.

It is highly recommended to store the module with temperature from 0 to 35 $\,^\circ\!\!C$ and relative humidity of less than 70%

(2) Do not store the TFT-LCD module in direct sunlight.

(3) The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.

(4) It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module.

In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.

(5) This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.

11. Packing

